

TOSHIBA MOS MEMORY PRODUCTS

T-46-23-14

**TC55257APL-85/APL-10/APL-12
TC55257AFL-85/AFL-10/AFL-12**

DESCRIPTION

The TC55257APL is 262,144 bit static random access memory organized as 32,768 words by 8 bits using CMOS technology, and operated from a single 5V supply. Advanced circuit techniques provide both high speed and low power features with a operating current of 5mA/MHz (Typ.) and minimum cycle time of 85ns. When CE is a logical high, the device is placed in low power standby mode in which standby current is 2μA typically. The TC55257APL has two control inputs. Chip enable (CE) allow for device selection and data retention control, and an output enable input (OE) provides fast memory access. Thus the TC55257APL is suitable for use in various microprocessor application systems where high speed, low power, and battery back up are required. The TC55257APL is offered in both a standard dual-in-line 28 pin plastic package (0.6 inch width) and small-out-line plastic flat package.

FEATURES

- Low Power Dissipation
27.5mW/MHz(Typ.) Operating
- Standby Current
100μA(Max.):
TC55257APL-85/AFL-85
APL-10/AFL-10
APL-12/AFL-12
- 5V Single Power Supply
- Power Down Feature: CE

- Data Retention Supply Voltage: 2.0~5.5V
- Access Time

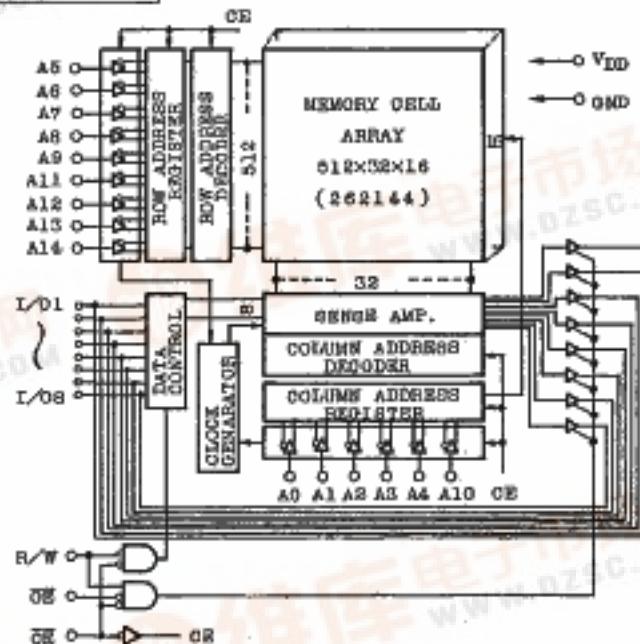
	TC55257APL-85 TC55257AFL-85	TC55257APL-10 TC55257AFL-10	TC55257APL-12 TC55257AFL-12
Access Time(Max.)	85ns	100ns	120ns
Chip Enable Access Time (Max.)	85ns	100ns	120ns
Output Enable Time (Max.)	45ns	50ns	60ns

- Directly TTL Compatible: All Inputs and Outputs
- Plastic DIP and Plastic PP Package

PIN CONNECTION (TOP VIEW)

A14	1	28	VDD
A12	2	27	R/W
A7	3	26	A13
A6	4	25	A8
A5	5	24	A9
A4	6	23	A11
A3	7	22	OE
A2	8	21	A10
A1	9	20	CE
A0	10	19	I/O8
I/O1	11	18	I/O7
I/O2	12	17	I/O6
I/O3	13	16	I/O5
GND	14	15	I/O4

BLOCK DIAGRAM



PIN NAMES

A0 ~ A14	Address Inputs
R/W	Read/Write Control Input
OE	Output Enable Input
CE	Chip Enable Input
I/O1 ~ I/O8	Data Input/Output
VDD	Power (+5V)
GND	Ground

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OPERATION MODE

OPERATION MODE	CE	OE	R/W	I/O1 ~ I/O8	POWER
Read	L	L	H	D _{OUT}	I _{DDO}
Write	L	*	L	D _{IN}	I _{DDO}
Output Deselect	L	H	H	High-Z	I _{DDO}
Standby	H	*	*	High-Z	I _{DDS}

*) H or L

MAXIMUM RATINGS

SYMBOL	ITEM	RATING	UNIT
V _{DD}	Power Supply Voltage	-0.3 ~ 7.0	V
V _{IN}	Input Voltage	-0.3* ~ 7.0	V
V _{I/O}	Input and Output Voltage	-0.5 ~ V _{DD} +0.5	V
P _D	Power Dissipation	1.0	W
T _{solder}	Soldering Temperature	260 ~ 10	°C · sec
T _{strg}	Storage Temperature	-55 ~ 150	°C
T _{opr}	Operating Temperature	0 ~ 70	°C

*) -3.0V at pulse width 50ns

D.C. RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	MIN.	TYP.	MAX.	UNIT
V _{DD}	Power Supply Voltage	4.5	5.0	5.5	V
V _{IH}	Input High Voltage	2.2	-	V _{DD} +0.3	V
V _{IL}	Input Low Voltage	-0.3*	-	0.8	V
V _{DH}	Data Retention Supply Voltage	2.0	-	5.5	V

*) -3.0V at pulse width 50ns

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D.C. and OPERATING CHARACTERISTICS (Ta=0 ~ 70°C, V_{DD}=5V±10%)

SYMBOL	PARAMETER	TEST CONDITION	MIN.	TYP.	MAX.	UNIT	
I _{IL}	Input Leakage Current	V _{IN} =0 ~ V _{DD}	-	-	±1.0	µA	
I _{OH}	Output High Current	V _{OH} =2.4V	-1.0	-	-	mA	
I _{OL}	Output Low Current	V _{OL} =0.4V	4.0	-	-	mA	
I _{LO}	Output Leakage Current	CE=V _{IH} or R/W=V _{IL} or OE=V _{IH} V _{OUT} =0 ~ V _{DD}	-	-	±1.0	µA	
I _{DD01}	Operating Current	V _{DD} =5.5V CE=V _{IL} , R/W=V _{IH} Other Input =V _{IH} /V _{IL} I _{OUT} =0mA	t _{cycle} =1µs	-	10	-	
I _{DD02}		V _{DD} =5.5V CE=0.2V, R/W=V _{DD} -0.2V Other Input =V _{DD} -0.2V/0.2V I _{OUT} =0mA	t _{cycle} = Min. cycle	-	70	mA	
I _{DDS1}	Standby Current	CE=V _{IH}	-	-	3	mA	
I _{DDS2}	Standby Current	CE=V _{DD} -0.2V V _{DD} =2.0 ~ 5.5V	Ta=0 ~ 70°C	-	2	100	µA

CAPACITANCE (Ta=25°C, f=1MHz)

SYMBOL	PARAMETER	TEST CONDITION	MAX.	UNIT
C _{IN}	Input Capacitance	V _{IN} =GND	10	pF
C _{OUT}	Output Capacitance	V _{OUT} =GND	10	pF

Note: This parameter periodically sampled is not 100% tested.

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A.C. CHARACTERISTICS (Ta=0~70°C, V_{DD}=5V±10%)

READ CYCLE

SYMBOL	PARAMETER	TC55257APL-85		TC55257APL-10		TC55257APL-12		UNIT
		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
t _{RC}	Read Cycle Time	85	-	100	-	120	-	ns
t _{AAC}	Address Access Time	-	85	-	100	-	120	
t _{CO}	CE Access Time	-	85	-	100	-	120	
t _{OE}	Output Enable to Output in Valid	-	45	-	50	-	60	
t _{COE}	Chip Enable (CE) to Output in Low-Z	10	-	10	-	10	-	
t _{OEE}	Output Enable to Output in Low-Z	5	-	5	-	5	-	
t _{OD}	Chip Enable (CE) to Output in High-Z	-	30	-	50	-	60	
t _{ODO}	Output Enable to Output in High-Z	-	30	-	40	-	50	
t _{OH}	Output Data Hold Time	5	-	10	-	10	-	

WRITE CYCLE

SYMBOL	PARAMETER	TC55257APL-85		TC55257APL-10		TC55257APL-12		UNIT
		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
t _{WC}	Write Cycle Time	85	-	100	-	120	-	ns
t _{WP}	Write Pulse Width	60	-	70	-	80	-	
t _{CW}	Chip Selection to End of Write	65	-	90	-	100	-	
t _{AS}	Address Set up Time	0	-	0	-	0	-	
t _{WR}	Write Recovery Time	5	-	5	-	5	-	
t _{ODW}	R/W to Output High-Z	-	30	-	50	-	60	
t _{OEW}	R/W to Output Low-Z	10	-	10	-	10	-	
t _{DS}	Data Set up Time	40	-	40	-	50	-	
t _{DH}	Data Hold Time	0	-	0	-	0	-	

A.C. TEST CONDITIONS

Output Load : 100pF + 1 TTL Gate

Input Pulse Level : 0.6V, 2.4V

Timing Measurement: 0.8V, 2.2V

Reference Level : 0.8V, 2.2V

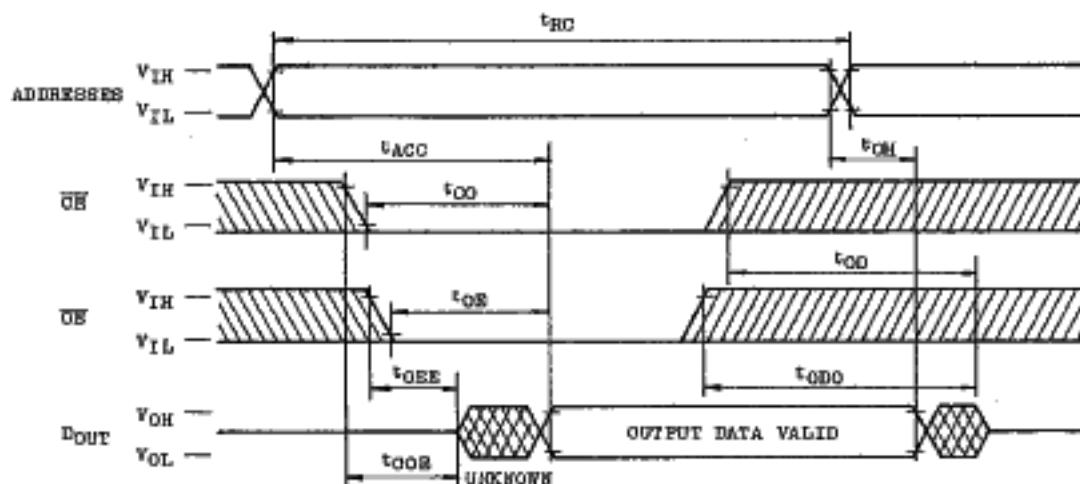
t_r, t_f : 5ns

TC55257APL-85/APL-10/APL-12
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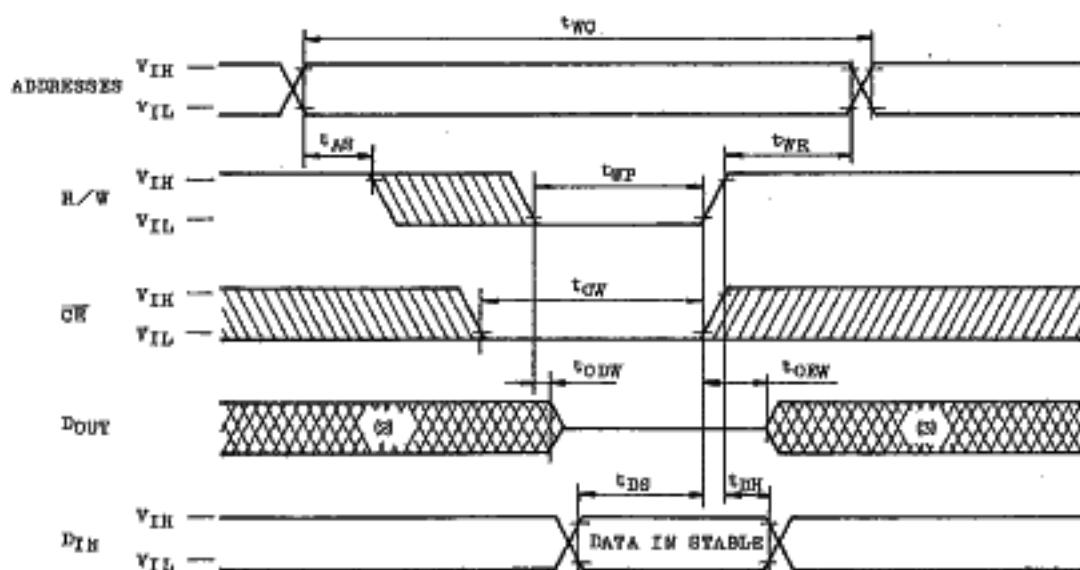
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TIMING WAVEFORMS

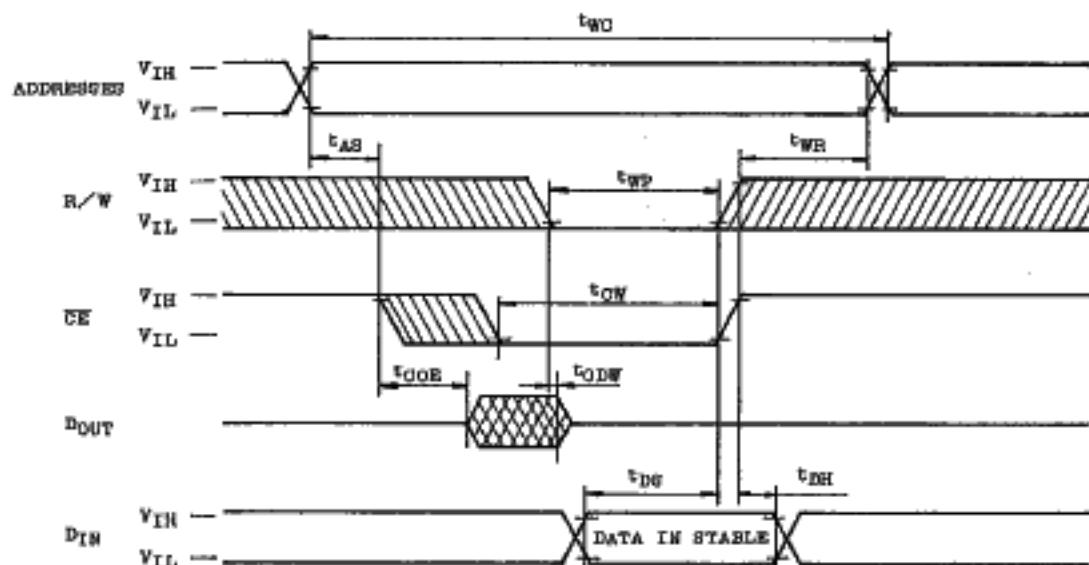
READ CYCLE (1)



WRITE CYCLE 1 (4) (R/W Controlled Write)



WRITE CYCLE 2 (4) (\overline{OE} Controlled Write)



- Note: 1. R/W is High for Read Cycle.
2. Assuming that CE low transition occurs coincident with or after R/W Low transition, Outputs remain in a high impedance state.
3. Assuming that CE High transition occurs coincident with or prior to R/W High transition, Outputs remain in a high impedance state.
4. Assuming that \overline{OE} is High for Write Cycle, Outputs are in high impedance state during this period.

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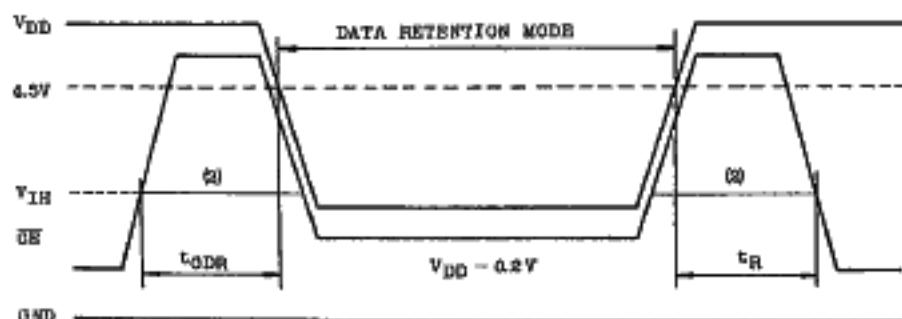
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DATA RETENTION CHARACTERISTICS (Ta=0 ~ 70°C)

SYMBOL	PARAMETER	MIN.	TYP.	MAX.	UNIT
V _{DH}	Data Retention Supply Voltage	2.0	-	5.5	V
I _{DSS2}	Standby Supply Current	V _{DH} =3.0V	-	-	50
		V _{DH} =5.5V	-	-	100
t _{CDR}	Chip Deselection to Data Retention Mode	0	-	-	μs
t _R	Recovery Time	t _{RC(1)}	-	-	μs

Note (1): Read Cycle Time.

CE Controlled Data Retention Mode



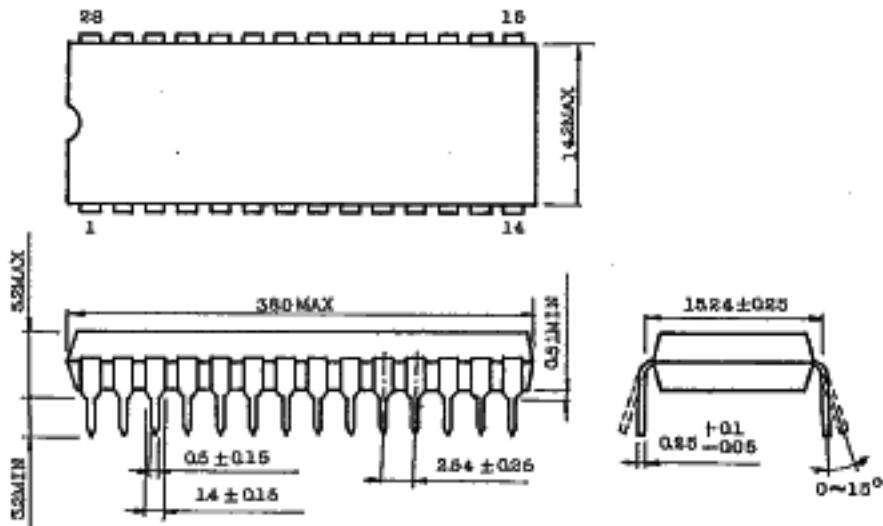
Note (2): If the V_{IH} of CE is 2.2V in operation, I_{DSS1} current flows during the period that the V_{DD} voltage is going down from 4.5V to 2.4V.

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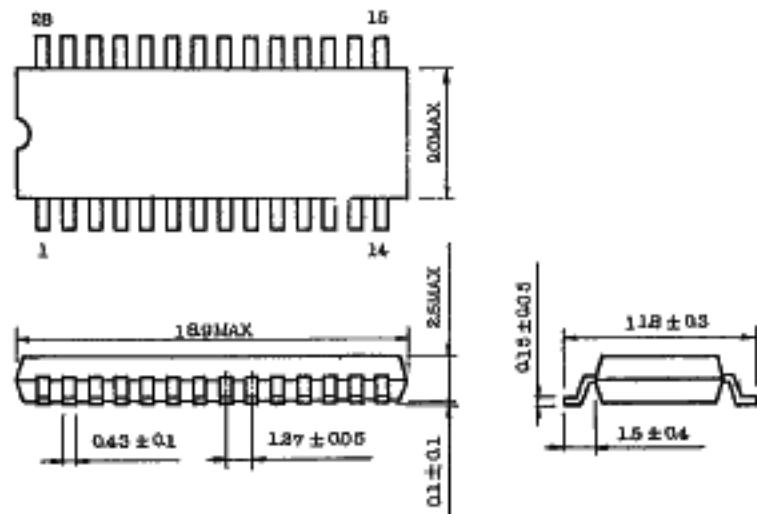
DIP 28 PIN OUTLINE DRAWING (6D28A-P)

Unit in mm



Note: Lead pitch is 2.54 and tolerance is ±0.25 against theoretical center of each lead that is obtained on the basis of No.1 and No.28 leads.

MFP 28 PIN OUTLINE DRAWING (F28GA-P)



Note: Lead pitch is 1.27 and tolerance is ±0.12 against theoretical center of each lead that is obtained on the basis of No.1 and No.28 leads.